

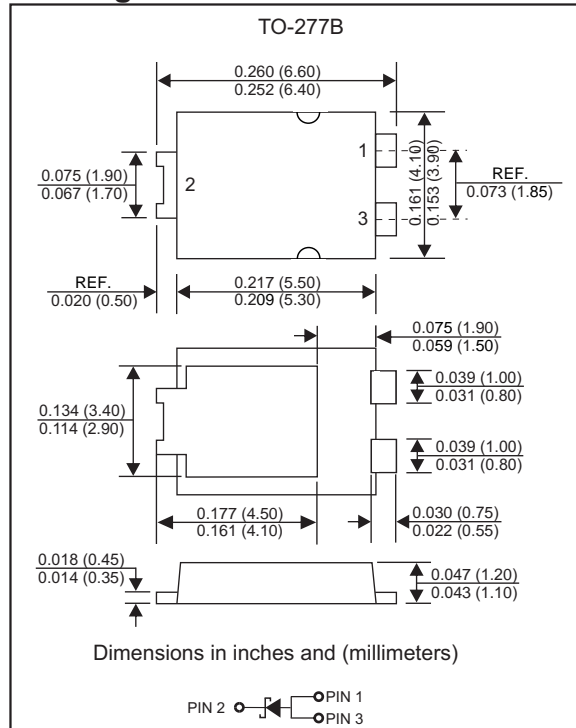
Features

- Ideal for automated placement
- Low power losses
- High forward surge capability
- Compliant to Halogen-free

Mechanical data

- Epoxy:UL94-V0 rated flame retardant
- Case : TO-277B ,molded Plastic
- Terminals: Tin plated leads, solderable per J-STD-002 and JESD22-B102
- Marking:SU10100

Package outline



Maximum ratings (AT $T_A=25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	VALUE	UNIT
Repetitive Peak Reverse Voltage	V_{RRM}	100	V
Average Rectified Output Current @ 60Hz -sine wave, R- load, $T_c=100^\circ\text{C}$	I_o	10	A
Forward Surge Current (Non-repetitive) @ 60Hz Half-sine wave, 1 cycle, $T_a=25^\circ\text{C}$	I_{FSM}	250	A
Current Squared Time @ $1\text{ms} \leq t \leq 8.3\text{ms}$ $T_j=25^\circ\text{C}$	I^2t	260	A^2s
Storage Temperature	T_{stg}	-55 ~ +150	$^\circ\text{C}$
Operating Junction Temperature	T_j	-55 ~ +150	$^\circ\text{C}$

Electrical Characteristics (AT $T_A=25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS	Min	Typ	Max	UNIT
Peak Forward Voltage	V_{FM}	$I_{FM}=10.0\text{A}, T_j=25^\circ\text{C}$	-	0.56	0.65	V
		$I_{FM}=10.0\text{A}, T_j=125^\circ\text{C}$	-	0.49	-	
Reverse Breakdown Voltage	V_{BR}	$I_R=0.5\text{mA}$	100	-	-	V
Leakage Current	I_R	$V_R=100\text{V}, T_j=25^\circ\text{C}$	-	-	0.1	mA
		$V_R=100\text{V}, T_j=100^\circ\text{C}$	-	-	10	

Note1:Pulse test:300uS pulse width, 1% duty cycle

Note2:Pulse test:pulse width 40mS

Thermal Characteristics

PARAMETER	SYMBOL	VALUE	UNIT
Thermal Resistance Junction to Ambient	$R_{\theta J-A}$	30	$^\circ\text{C}/\text{W}$
Thermal Resistance Junction to Case	$R_{\theta J-C}$	8	$^\circ\text{C}/\text{W}$

Rating and characteristic curves

FIG.1: I_o - T_c Curve

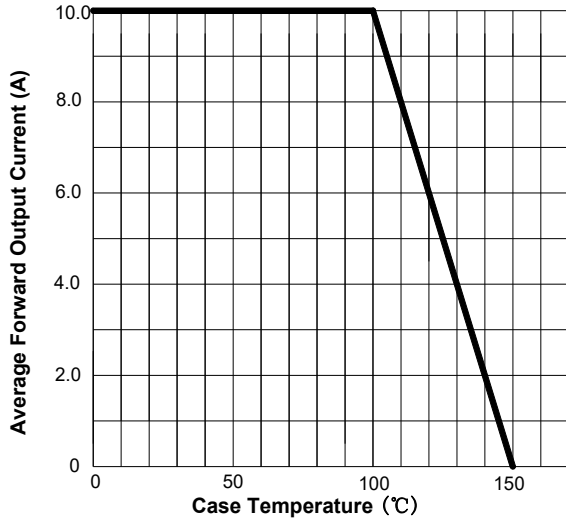


FIG.2: Forward Surge Current Capability

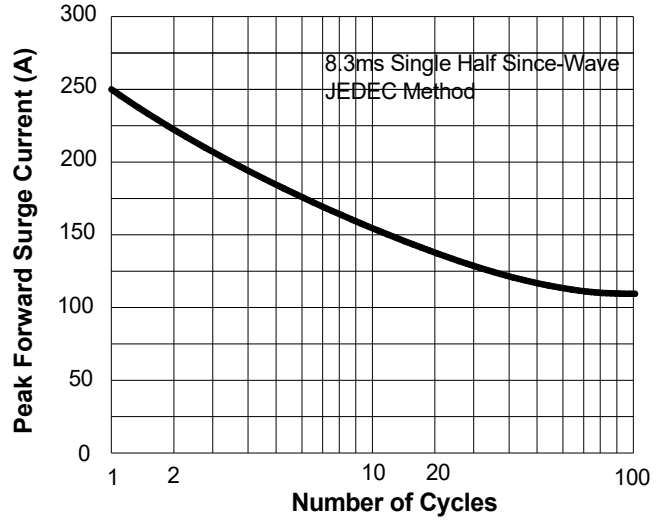


FIG.3: Forward Voltage

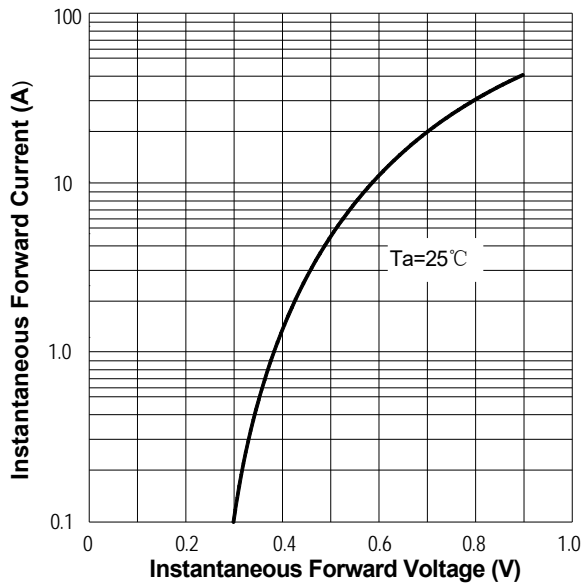
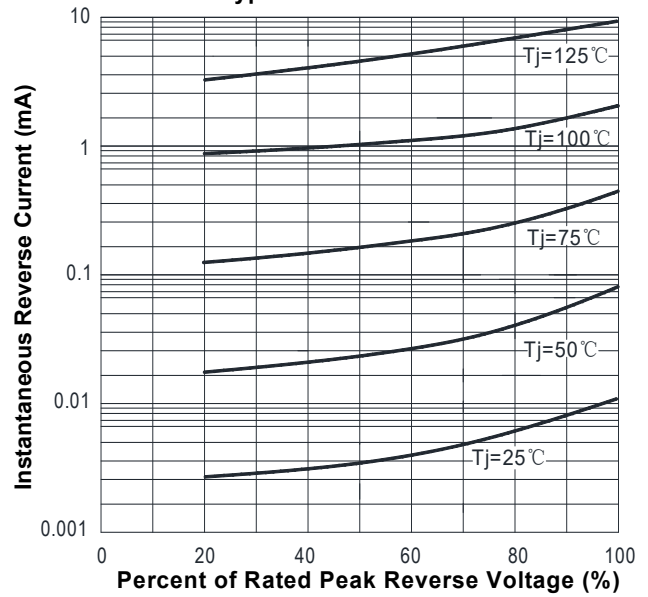
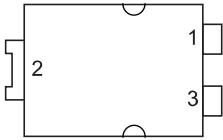
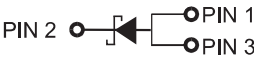


FIG.4: Typical Reverse Characteristics



Pinning information

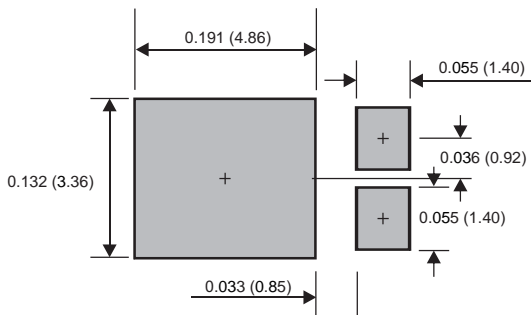
Pin	Simplified outline	Symbol
Pin2 cathode Pin1 anode Pin3 anode		

Marking

Type number	Marking code
SU10100Y-T	SU10100

Suggested solder pad layout

TO-277B



Dimensions in inches and (millimeters)